

# ***INTRAWEAPON WIRELESS COMMUNICATION***

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# Outline

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- *System*
- *Spin Dependent Tunneling (SDT) or Magnetic Tunnel Junction (MTJ) Sensor Technology*
- *Applications of SDT Sensors To Intraweapon Communication*
- *Fuzing and Surveillance.*



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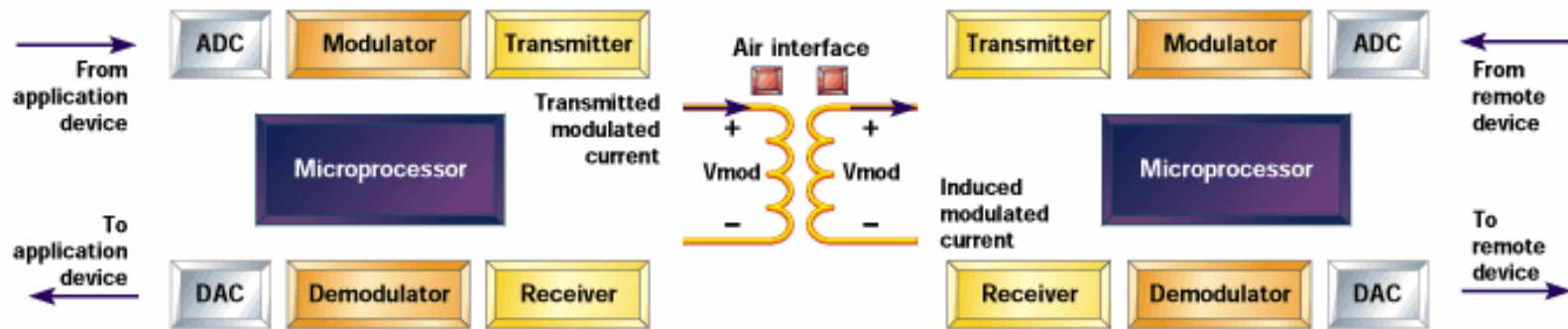


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# Intraweapon Wireless Communication System



*The magnetic induction system communicates by setting up a quasi-static field around the transmitting coil. Current Commercial applications include wireless headsets, MP3 players and medical devices.*

# Magnetic Communication

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- *Unlike RF communication that propagates an E-field plane wave in free space.*
- *Magnetic system sets up a quasi-static magnetic field around transmitting coil*
- *Second coil intersects the time varying magnetic flux density (B-field).*
- *Modulated voltage is processed and data recovered.*
- *RF uses E-field, Magnetic uses B-field.*



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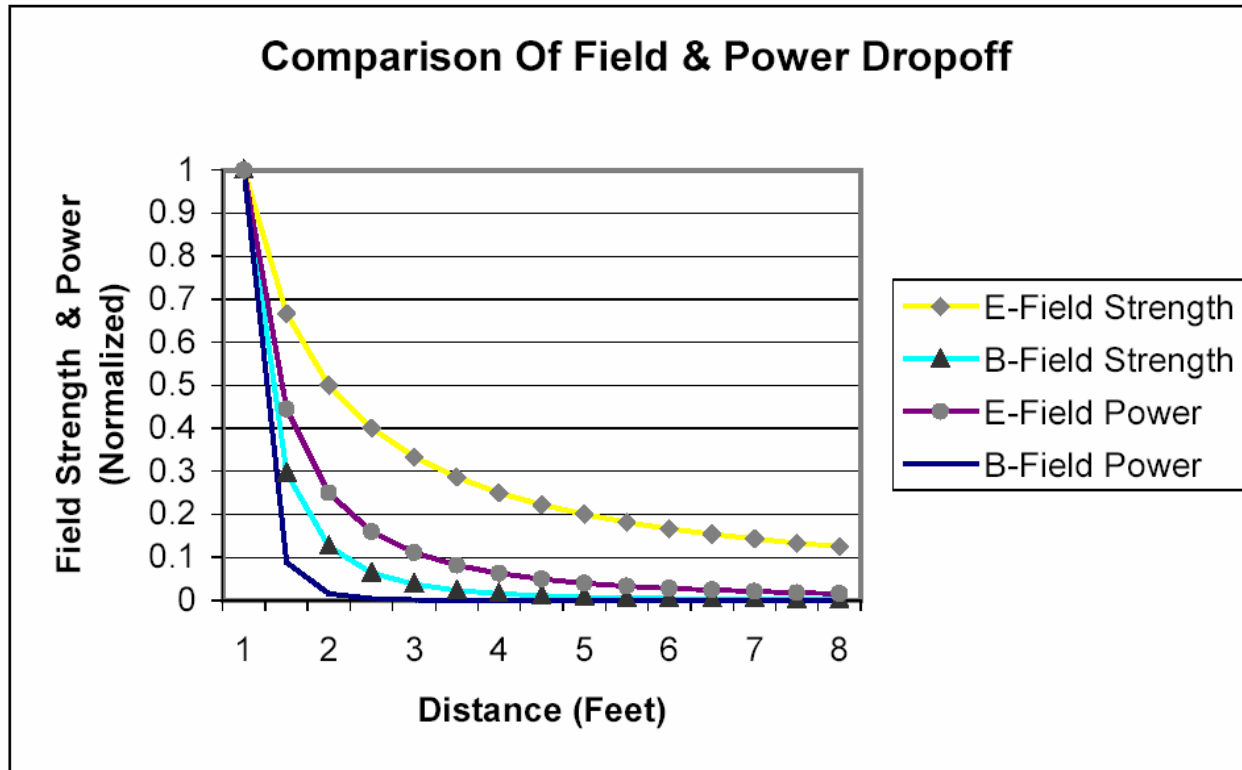


# *Magnetic Induction vs. RF Wireless Characteristics*

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- *Wireless propagates RF plane wave*
  - *Flow of energy from transmitter to receiver*
  - *RF is not contained -- **security** risk*
- *Magnetic induction remains localized*
  - *Little flow of energy*
- *Magnetic induction system very localized*
  - *Magnetic fields decrease as inverse cube of distance*

# Magnetic Induction vs. RF Wireless



The magnetic field (B-field) component drops off at a  $1/R^3$  compared to an RF plane wave that drops off at  $1/R$ .

$$\text{Energy } E \sim B^2$$
$$E \sim 1/R^6$$

# *Magnetic Induction Communication Considerations*

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- *Survivability After Weapon Penetration*
- *Sizing and Hardening of Transmitter Unit*
- *Required Receiver Sensor (SDT) Sensitivity*
- *System Power*
- *Size*
- *Cost*



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# Magnetic Field Transmitter Considerations

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- *The bomb casing will act as a shield to the incoming magnetic vehicle signatures but absorb internal signal.*
- *Communication effectiveness is composed of 3 complicating factors: absorption losses (flux shunting), reflection losses, and secondary reflection losses.*
- *The complex calculations are a function of structure geometry, permeability, conductivity, and frequency, all interactively nonlinear.*
- *The major factor for our application is reducing absorption losses.*



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# *Magnetic Field Detector Considerations*

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- *Pickup coil responds to  $dB/dt$* 
  - *Voltage output is proportional to frequency*
  - *Large coils and many turns required at low frequencies*
- *Magnetic field detectors (SDT Sensors) respond to B Fields*
  - *Voltage output frequency independent*
  - *Very small, very light solid-state sensors*



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# *SDT Magnetic Receivers*

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- *Quantum tunneling of electrons through a thin insulator between two magnetic layers*
- *Tunneling current is effected by the relative orientation of magnetic moment in layers*
- *One magnetic layer pinned and one layer free to respond to external fields*
- *All current passes through the interface-high Tunneling Magneto Resistance (TMR) (high sensitivity)*
- *Extremely high resistance per unit area (low power)*



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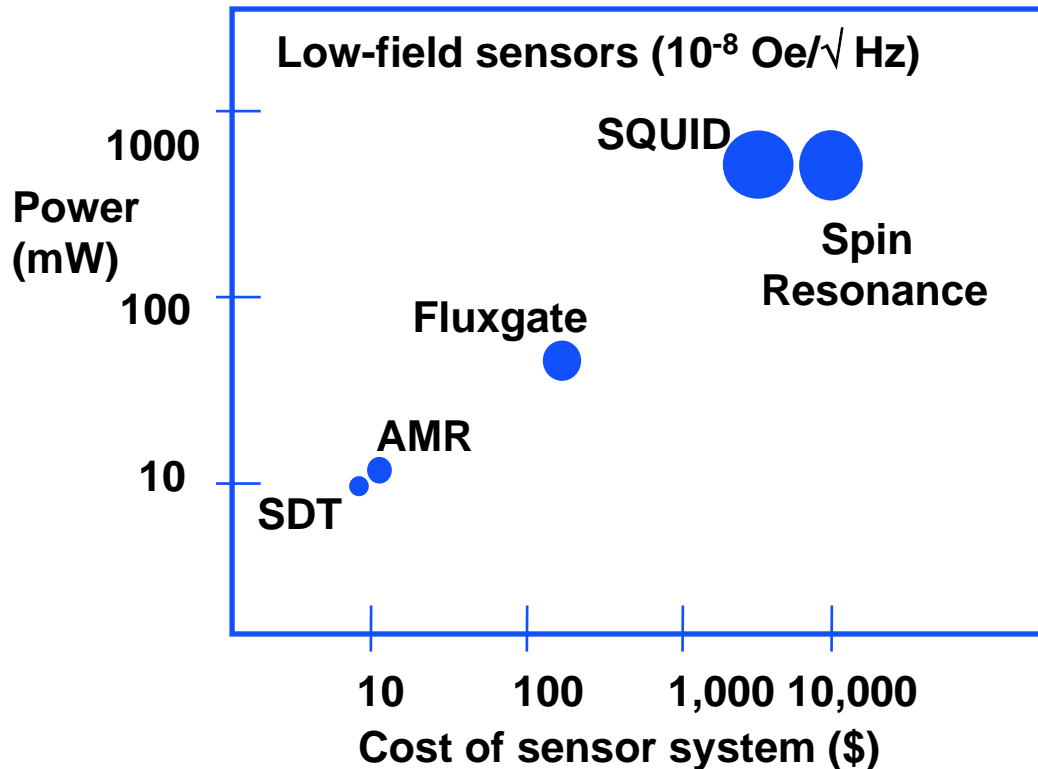


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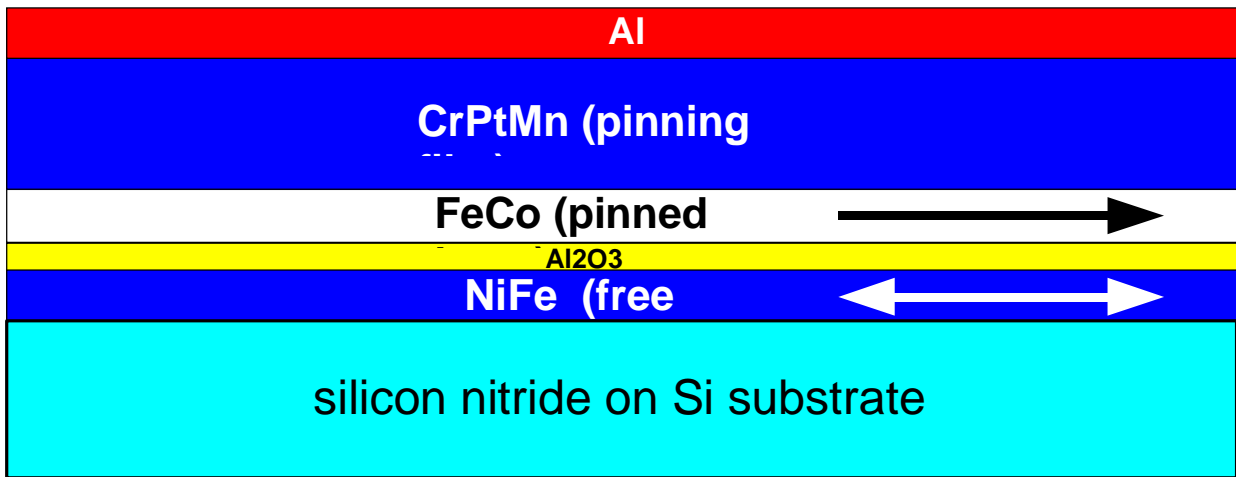
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# Very Low Field Magnetic Sensing/Receiver



# SDT Layer Structure

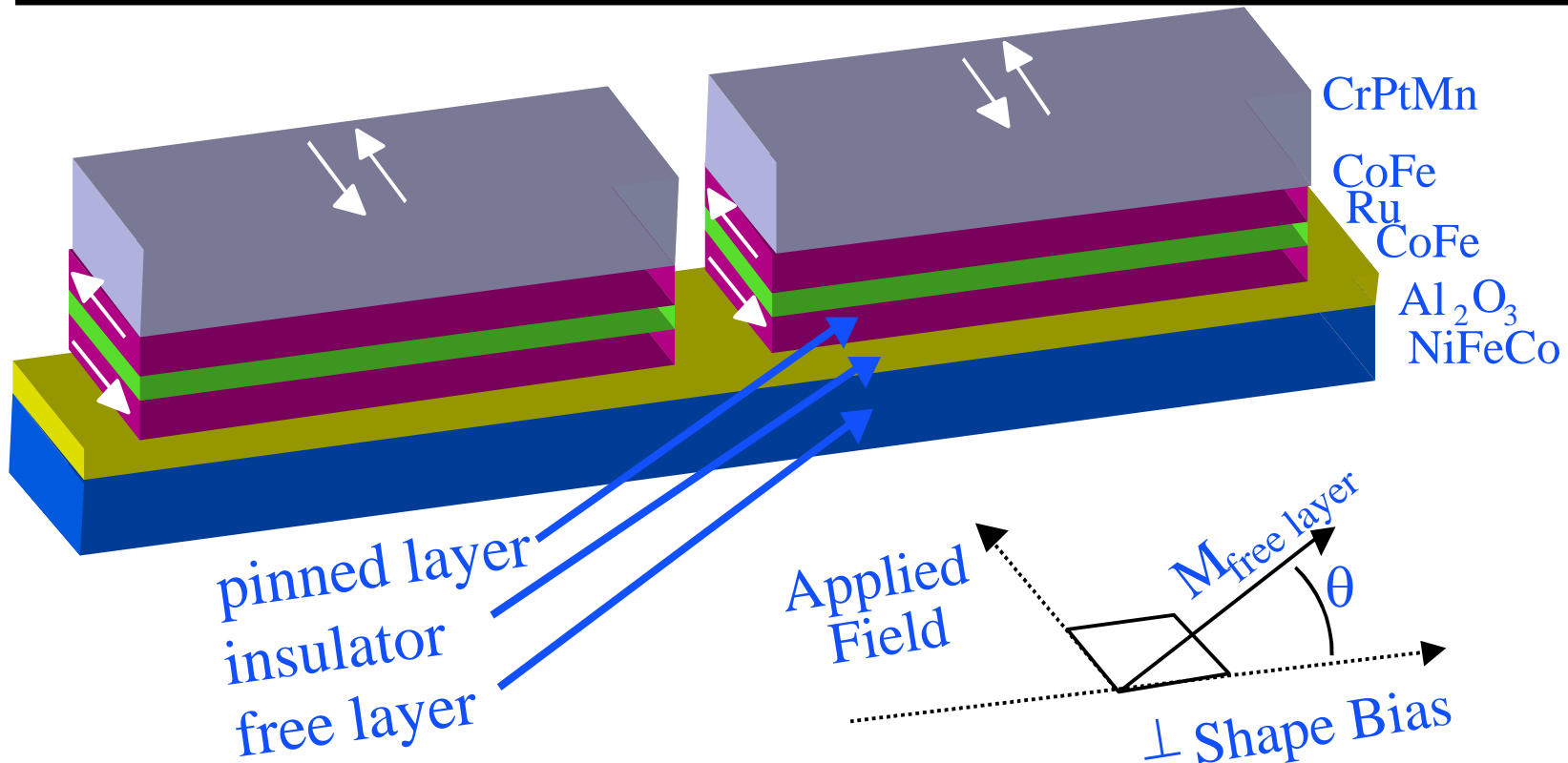


Sensing direction  
and easy axis  
of the free layer.

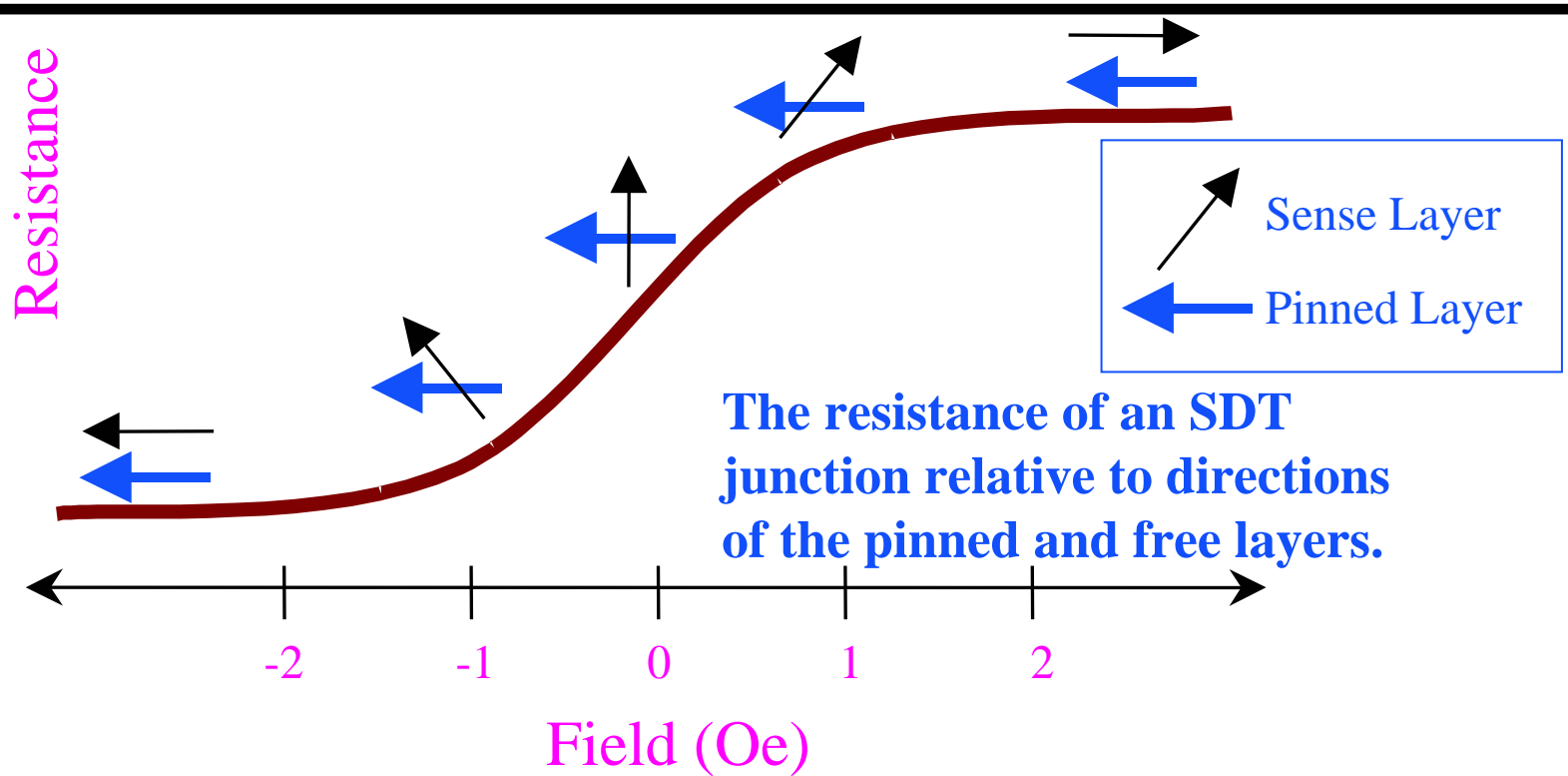


*The resistance of the sensor is measured by feeding a current vertically through the stack including through or “tunneling” through the insulating layer.*

# Individual SDT Sensor



# Current SDT Sensor Response



# Low Power SDT Sensor

## Operational Tradeoffs

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- Resolution of the SDT sensor is determined by the amount of system power available
- The higher the required resolution, the higher the power required.
- The two variables that can be manipulated are sensor resistance and amplifier supply
- SDT sensors can be manufactured from tens of  $\Omega$ s to 100s of  $K\Omega$ s.
- Sensitivity is a tradeoff to power consumption



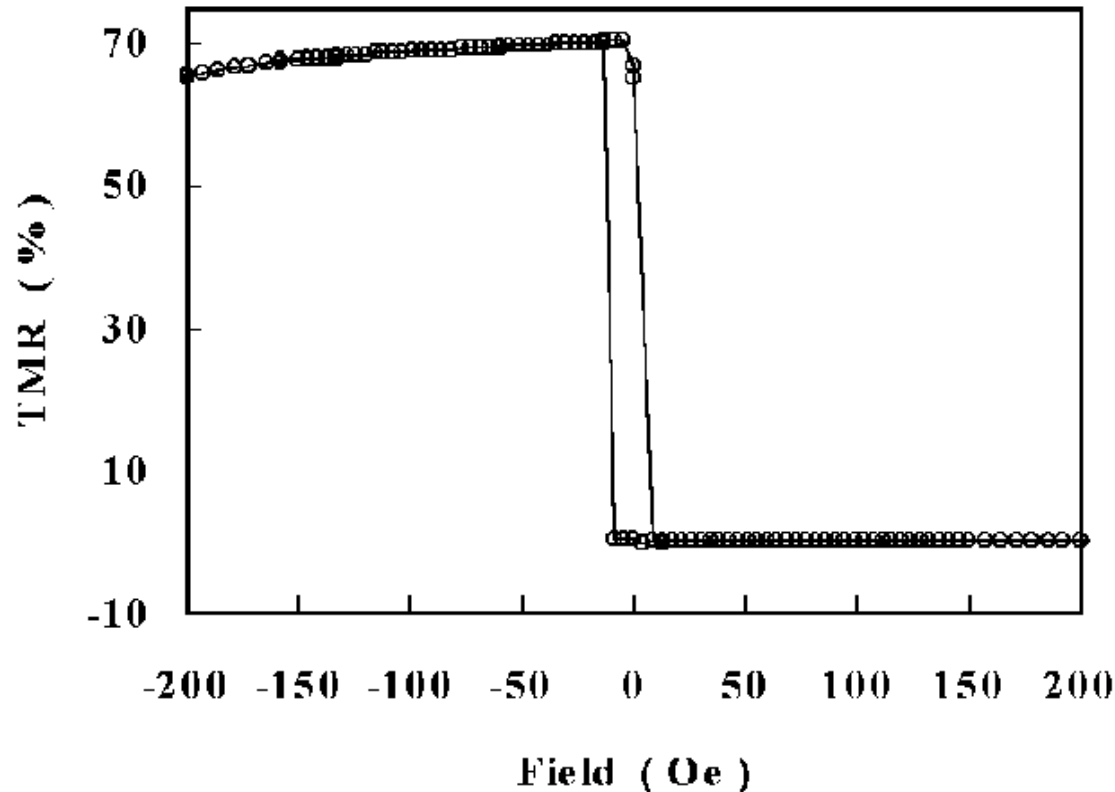
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# Record 70% TMR Reported



*% TMR indicates the % change in resistance with a given applied field.*

*This TMR was recently reported in a recent research project.*



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# *Applications of SDT Sensors To Intraweapon Communication*

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- *SDT sensors packaged in SOIC packages*
  - *Small*
  - *Lightweight*
  - *No connections to external antenna necessary*
- *Output 100 mV/Oe with 5 V supply*
  - *Frequency independent output voltage*
  - *Extracts no power from signal*



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# Conclusions

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- *SDT sensors will develop sensitive, power and cost effective sensing for intraweapon communication as well as fuzing and surveillance systems*
- *Magnetometer applications*
  - *Unattended Networks*
  - *Security*
  - *UXO*
  - *Traffic Management*



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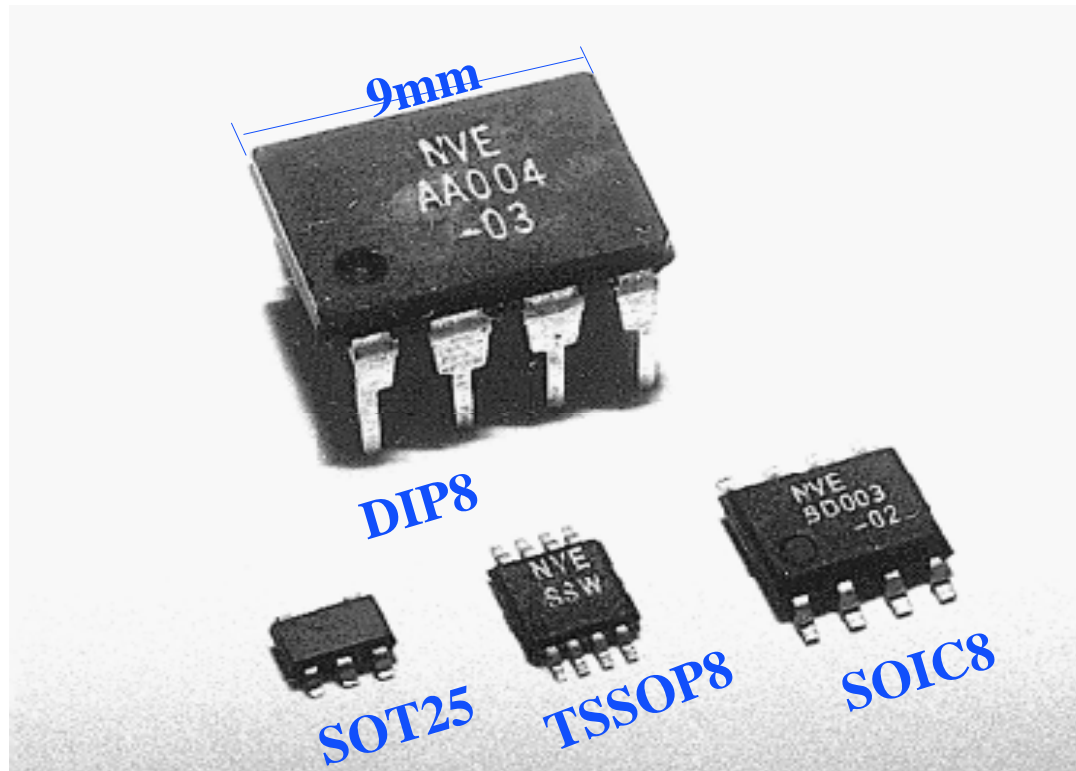


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# NVE Sensor Packages



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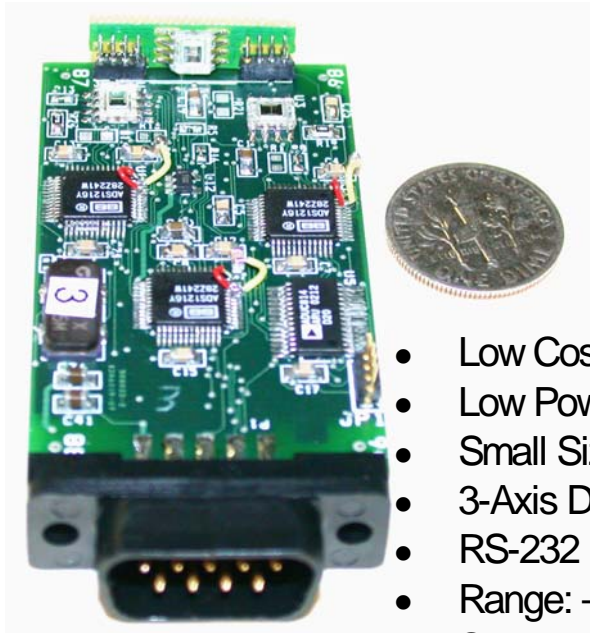


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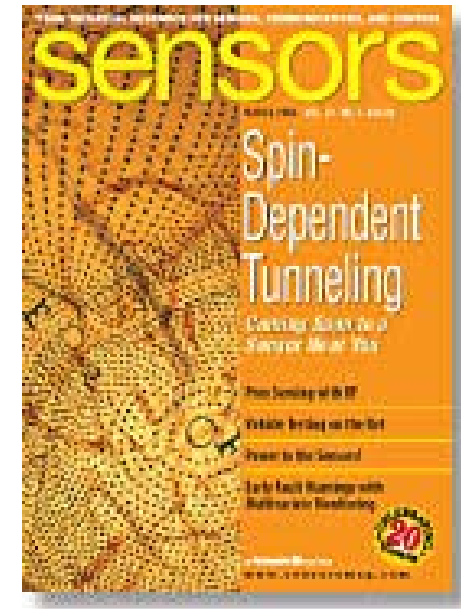
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# 3-Axis Smart Digital Magnetometer Using SDT



- Low Cost
- Low Power
- Small Size
- 3-Axis Digital Resolution
- RS-232 Interface: 9600/19200 Baud or RS-485
- Range:  $-1$  to  $+20e$ ,  $1\mu Oe$  Resolution
- Signal bandwidth: 154Hz
- Available in a Port-Powered Version



# Acknowledgments

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